

Safety Certificated Capacitors X2/Y3







■ HOW TO ORDER

S 3	42	N	100	J	202	L	Т
<u>Series</u>	<u>Size</u>	<u>Dielectric</u>	<u>Capacitance</u>	<u>Tolerance</u>	Rated voltage	<u>Termination</u>	<u>Packaging</u>
S3=X2/Y3	42=1808 (4520) 43=1812 (4532)	N=NPO (COG) B=X7R	Two significant digits followed by no. of zeros. And R is in place of decimal point. Eg.: R47=4.7pF OR5=0.5pF 1R0=1.0pF 100=10x10° =10pF	J=±5% K=±10%	Two significant digits followed by no. of zeros. And R is in place of decimal point. 202=2000 VDC 302=3000 VDC	L=Ag/Ni/Sn	B=Bulk T=7" reeled

■ PACKAGING DIMENSION AND QUANTITY

Size	Thickness (mm)/Symbol		7" reel / Plastic tape
1808 (4520)	1.25±0.10	D	2k
1000 (4320)	2.00±0.20	K	1k
1812 (4532)	1.25±0.10	D	1k
1012 (4332)	2.00±0.20	K	1k

Unit: pieces



Safety Certificated Capacitors X2/Y3

■ CAPACITANCE RANGE

NPO Dielectric

Dielectric		NPO				
	Size		1808	1812		
Rat	ed voltage (VAC)	250		250		
Rat	ed Voltage (VDC)	2000	3000	2000	3000	
	3.9pF (3R9)		D*			
	4.7pF (4R7)		D*			
	5.0pF (5R0)		D*			
	5.6pF (5R6)		D*			
	6.8pF (6R8)		D*			
	8.2pF (8R2)		D*			
	10pF (100)	D	D	D*	D*	
	12pF (120)	D	D	D	D	
	15pF (150)	D	D	D	D	
	18pF (180)	D	D	D	D	
	22pF (220)	D	D	D	D	
	27pF (270)	D	D	D	D	
2	33pF (330)	D	D	D	D	
<u>I</u>	39pF (390)	D	D	D	D	
Capacitance	47pF (470)	D	D	D	D	
<u>8</u>	56pF (560)	D	D	D	D	
	68pF (680)	D	D	D	D	
	82pF (820)	D	D	D	D	
	100pF (101)	D	D	D	D	
	120pF (121)	D	D	D	D	
	150pF (151)	D	D	D	D	
	180pF (181)	D	K	D	D	
	220pF (221)	D	K	D	D	
	270pF (271)	D	K	D	K	
	330pF (331)	D		D	K	
	390pF (391)	K		D	K	
	470pF (471)	K		D	K	
	560pF (561)	K		D		
	680pF (681)	K		K		
	820pF (821)			K		
	1,000pF (102)	_		K		

[&]quot;*" means it is only available for UL safety certificated.

X7R Dielectric

Dielectric		X7R				
	Size		1808	1812		
	ted voltage (VAC)		250		250	
Rat	ed Voltage (VDC)	2000	3000	2000	3000	
	150pF (151)	D				
	180pF (181)	D				
	220pF (221)	D				
	270pF (271)	D		D		
	330pF (331)	D		D		
	390pF (391)	D		D		
	470pF (471)	D		D		
d)	560pF (561)	D	K	D		
Capacitance	680pF (681)	D	K	D	K	
g: I	820pF (821)	D	K	D	K	
<u>8</u>	1,000pF (102)	K	K	D	K	
	1,200pF (122)	K		D		
	1,500pF (152)	K		D		
	1,800pF (182)	K		D		
	2,200pF (222)	K		D		
	2,700pF (272)			D		
	3,300pF (332)			K		
	3,900pF (392)			K		
	4,700pF (472)			К		

^{1.} The letter in cell is expressed the symbol of product thickness.

^{1.} The letter in cell is expressed the symbol of product thickness.

^{2.} For more information about products with special capacitance or other data, please contact WTC local representative.

^{2.} For more information about products with special capacitance or other data, please contact WTC local representative.



Appendix I: Reliability Test Conditions and Requirements

NO.	Item	Test Condition	Requirements			
1.	Visual and Mechanical		No remarkable defect. Dimensions to confirm to individual specification sheet.			
2.	Capacitance	Class I : NPO	* Shall not exceed the limits given in the detailed spec.			
3.	Q/ D.F. (Dissipation Factor)	Cap 1000pF 1.0±0.2Vrms, 1MHz±10% Cap>1000pF 1.0±0.2Vrms, 1KHz±10%	NPO: Cap 30pF, Q 1000; Cap<30pF, Q 400+20C X7R, X5R:			
	(Dissipation ractor)	OLAND VED VED	Rated vol. D.F. Exception of D.F.			
		Class II : X7R, X5R, Y5V Cap 10µF, 1.0±0.2Vrms, 1KHz±10%	50V 2.5% 3.0% All 0201;0603 0.047μF;0805 0.18μF; 1206 0.47μF			
		Cap>10μF, 0.5±0.2Vrms, 120Hz±20%	25V 3.5% 5.0% 0805 1μF, 1210 10μF			
			7.0% 0603 0.33µF;TT series & Cap 1µF			
			16V 3.5% 0805 0.68μF;1206 2.2μF			
			10% TT series & Cap 1μF 10V 5.0% 10.0% TT series & Cap 1μF;0805 10μF			
			6.3V 10.0% 15.0% 0805 22μF;1210 100μF			
			Y5V:			
			Rated vol. D.F. Exception of D.F. 50V 5.0%			
			35V 7.0%			
			7.0% 0603 0.1µF; 0805 0.33µF;			
			25V 5.0% 7.0% 1206 1μF; 1210 4.7μF 9.0% 0402 0.068μF			
			16V (C<1.0μF) 7.0% 9.0% 0402 0.068μF; 0603 0.68μF			
			16V (C 1.0μF) 9.0% 12.5% 0805 4.7μF;1206 10μF;1210 22μF			
			10V 12.5% 6.3V 20.0%			
			0.07			
4a.	Dielectric Strength	* To apply voltage (50V) 250%. * Duration: 1 to 5 sec.	* No evidence of damage or flash over during test.			
		* Charge & discharge current less than 50mA.				
		* To apply voltage :				
		100V 3 times V DC				
		200V ~ 300V 2 times V DC 500V ~ 999V 1.5 times V DC				
	1000V ~ 3000V 1.2 times V DC					
		* Cut-off, set at 10mA * TEST= 15 sec.				
		* RAMP=0				
4b.	Dielectric Strength	* To apply 1500 VAC voltage.	* No evidence of damage or flash over during test.			
	(for X1/Y2 & X2/Y3)	* Duration: 60 sec.	the order to adming or had noted adming took			
5.	Insulation	To apply rated voltage for max. 120 sec.	10G or RxC 500 -F whichever is smaller.			
	Resistance	Rated voltage: To apply rated voltage for 60 sec.	10G			
		100 ~ 500V				
		Rated voltage: > 500V To apply 500V for 60 sec.	10G			
6.	Temperature	With no electrical load.				
0.	Coefficient	T.C. Operating Temp	T.C. Capacitance Change			
		NPO (COG) -55~125°C at 25°C	NPO (COG) Within ±30ppm/°C			
		NPO (COJ) -55~125°C at 25°C	NPO (COJ) Within ±120ppm/°C			
		X7R -55~125°C at 25°C X5R -55~85°C at 25°C	X7R Within ±15% X5R Within ±15%			
		Y5V -25~85°C at 20°C	Y5V Within ±13 % Y5V Within ±13 %			
7.	Adhesive Strength of Termination	* Pressurizing force: 0201: 2N	* No remarkable damage or removal of the terminations.			
	or remination	0201: 2N 0402 & 0603: 5N				
		>0603: 10N				
		* Test time: 10±1 sec.				
8.	Vibration	* Vibration frequency: 10~55 Hz/min.	* No remarkable damage.			
	Resistance	* Total amplitude: 1.5mm	* Cap change and Q/D.F.: To meet initial spec.			
		* Test time: 6 hrs. (Two hrs each in three mutually perpendicular directions.)				
) - - - - - - - - -				



Appendix I: Reliability Test Conditions and Requirements

NO.	Item	Test Condition	Requirements		
9.	Solderability	* Solder temperature: 235±5°C * Dipping time: 2±0.5 sec.	95% min. coverage of all metalized area.		
10.	Bending Test	* The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm per second until the deflection becomes 1 mm and then the pressure shall be maintained for 5±1 sec. * Measurement to be made after keeping at room temp. for 24±2 hrs.	* No remarkable damage. * Cap change: NP0: within ±5.0% or ±0.5pF whichever is larger. X7R, X5R: within ±12.5% Y5V: within ±30% (This capacitance change means the change of capacitance under specified flexure of substrate from the capacitance measured before the test.)		
11.	Resistance to Soldering Heat	* Solder temperature: 270±5°C * Dipping time: 10±1 sec * Preheating: 120 to 150°C for 1 minute before immerse the capacitor in an eutectic solder. * Before initial measurement (Class II only): Perform 150+0/-10°C for 1 hr and then set for 48±4 hrs at room temp. * Measurement to be made after keeping at room temp. for 24±2 hrs. (Class I) or 48±4 hrs. (Class II).	* No remarkable damage. * Cap change: NP0: within ±2.5% or ±0.25pF whichever is larger. X7R, X5R: within ±7.5% Y5V: within ±20% * Q/D.F., I.R. and dielectric strength: To meet initial requirements. * 25% max. leaching on each edge.		
12.	Temperature Cycle	* Conduct the five cycles according to the temperatures and time. Step Temp. (°C) Time (min.) 1 Min. operating temp. +0/-3 30±3 2 Room temp. 2~3 3 Max. operating temp. +3/-0 30±3 4 Room temp. 2~3 * Before initial measurement (Class II only): Perform 150+0/-10°C for 1 hr and then set for 48±4 hrs at room temp. * Measurement to be made after keeping at room temp. for 24±2 hrs. (Class I) or 48±4 hrs. (Class II).	* No remarkable damage. * Cap change: NPO: within ±2.5% or ±0.25pF whichever is larger. X7R, X5R: within ±7.5% Y5V: within ±20% * Q/D.F., I.R. and dielectric strength: To meet initial requirements.		
13.	Humidity (Steady State)	* Test temp.: 40±2°C * Humidity: 90~95% RH * Test time: 500+24/-0hrs. * Measurement to be made after keeping at room temp. for 24±2 hrs. (Class I) or 48±4 hrs. (Class II).	* No remarkable damage. * Cap change: NPO: within ±5.0% or ±0.5pF whichever is larger. X7R, X5R: 10V, within ±12.5% 6.3V, within ±25% Y5V: within ±30% * Q/D.F. value: NPO: Cap 30pF, Q 350; 10pF Cap<30pF, Q 275+2.5C Cap<10pF; Q 200+10C X7R, X5R: Rated vol. D.E. Exception of D.F. 50V 3.0% 6.0% 0603 0.047µF; 0805 0.18µF; 1206 0.47µF 25V 5.0% 10.0% 0805 1µF, 1210 10µF 14.0% 0603 0.33µF 16V 5.0% 10.0% 0402 0.033µF; 0603 0.15µF; 0805 0.68µF; 1206 2.2µF 10V 7.5% 15.0% 0805 2.2µF; 1206 2.2µF, TT series & Cap 1µF 6.3V 15.0% 30.0% 0805 10µF; 1210 100µF Y5V: Rated vol. D.F. Exception of D.F. 50V 7.5% 35V 10.0% 10.0% 0603 0.1µF; 0805 0.33µF; 1206 1µF; 1210 4.7µF 12.5% 0402 0.068µF 16V (C<1.0µF) 10.0% 12.5% 0402 0.068µF 16V (C 1.0µF) 12.5% 10V 15.0%		



Appendix I: Reliability Test Conditions and Requirements

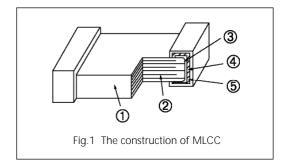
NO.	Item	Test Condition	Requirements			
14.	Humidity Load (Damp Heat)		* No remarkable damage. * Cap change: NP0: within ±7.5% or ±0.75pF whichever is larger. X7R, X5R: 10V, within ±12.5% 6.3V, with ±25% Y5V: 10V, within ±30% 6.3V, within ±30 to -40% * Q/D.F. value: NP0: Cap 30pF, Q 200; Cap<30pF, Q 100+10/3C			
			X7R, X5R: Rated vol. D.F. Exception of D.F.			
			Rated vol. D.F. Exception of D.F. 50V 7.5%			
15.	High Temperature Load (Endurance)	* Test temp.: NPO, X7R: 125±3°C X5R, Y5V: 85±3°C * To apply voltage: (1) 6.3V or C 10µF (for X7R, X5R): 150% of rated voltage. (2) 6.3V <v<500v (3)="" (4)="" (class="" (for="" (max.="" *="" -0="" 1000+24="" 120%="" 150%="" 200%="" 24±2="" 3600v)="" 48±4="" 500v:="" 630v:="" after="" and="" at="" be="" c<10µf="" for="" hrs.="" i)="" ii).<="" keeping="" made="" measurement="" of="" or="" rated="" room="" temp.="" test="" th="" time:="" to="" v="" voltage.="" x5r):="" x7r,=""><th>* No remarkable damage. * Cap change: NPO: within ±3.0% or ±0.3pF whichever is larger. X7R, X5R: 10V, within ±12.5% 6.3V, with ±25% Y5V: 10V, within ±30% 6.3V, within ±30 to -40% * Q/D.F. value: NPO: Cap 30pF, Q 350 10pF Cap<30pF, Q 275+2.5C Cap<10pF, Q 200+10C X7R, X5R: Rated vol. D.F. Exception of D.F. 50V 3.0% 6.0% 0603 0.047µF; 0805 0.18µF, 1206 0.47µF 25V 5.0% 10.0% 0805 1µF, 1210 10µF 14.0% 0603 0.33µF 16V 5.0% 10.0% 0805 0.68µF; 1206 2.2µF 10V 7.5% 15.0% 0805 2.2µF; 1206 2.2µF TT series & Cap 1µF</th></v<500v>	* No remarkable damage. * Cap change: NPO: within ±3.0% or ±0.3pF whichever is larger. X7R, X5R: 10V, within ±12.5% 6.3V, with ±25% Y5V: 10V, within ±30% 6.3V, within ±30 to -40% * Q/D.F. value: NPO: Cap 30pF, Q 350 10pF Cap<30pF, Q 275+2.5C Cap<10pF, Q 200+10C X7R, X5R: Rated vol. D.F. Exception of D.F. 50V 3.0% 6.0% 0603 0.047µF; 0805 0.18µF, 1206 0.47µF 25V 5.0% 10.0% 0805 1µF, 1210 10µF 14.0% 0603 0.33µF 16V 5.0% 10.0% 0805 0.68µF; 1206 2.2µF 10V 7.5% 15.0% 0805 2.2µF; 1206 2.2µF TT series & Cap 1µF			
			11 Series & Cap TµF			



Appendix II: General Information

Constructions

No.	Na	me	NPO/X7R	X7R/X5R/Y5V
1	Ceramic	material	BaTiO ₃	based
2	Inner el	ectrode	AgPd alloy	Ni
3		Inner layer	Ag	Cu
4	Termination	Middle layer	Ni	
5		Outer layer	Sn (N	Matt)



Storage and handling conditions

- (1) To store products at 5 to 40°C ambient temperature and 20 to 70%. related humidity conditions.
- (2) The product is recommended to be used within one year after shipment. Check solderability in case of shelf life extension is needed.

Cautions:

- a. Don't store products in a corrosive environment such as sulfide, chloride gas, or acid. It may cause oxidization of electrode, which easily be resulted in poor soldering.
- b. To store products on the shelf and avoid exposure to moisture.
- c. Don't expose products to excessive shock, vibration, direct sunlight and so on.

Recommended soldering conditions

The lead-free termination MLCCs are not only to be used on SMT against lead-free solder paste, but also suitable against lead-containing solder paste. If the optimized solder joint is requested, increasing soldering time, temperature and concentration of N₂ within oven are recommended.

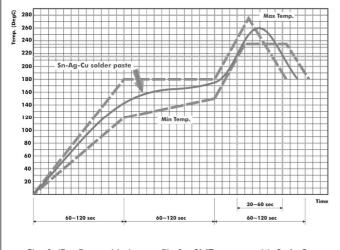


Fig. 2 IR reflow soldering profile for SMT process with SnAgCu series solder paste.

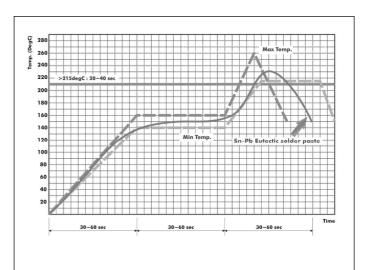


Fig. 3 IR reflow soldering profile for SMT process with eutectic SnPb solder paste.